Number	Template type, parameters, fabrication method	Metal nanostructure type, parameters, method	Analyte, detection limit, excitation wavelength	Refe- rence
		Microporous Si		
1	Microporous Si, <i>p</i> Si, pore diameter < 2 nm, anodization	Ag NPs, diameter 30 nm, immersion, 10 <sup>-2</sup> M AgNO3, 6 min	R6G, 10 <sup>-9</sup> M, 514.5 nm	[89]
		Mesoporous Si		
2	Mesoporous Si, <i>p</i> +-Si, pore diameter 32 nm, porosity 52 – 77%, anodization	Ag NPs, oxidation, thermal decomposition, 10 <sup>-3</sup> M AgNO <sub>3</sub> , 500°C	R6G, 1.14·10 <sup>-7</sup> M, adenine, 9·10 <sup>-6</sup> M, 785 nm	[17]
3	Mesoporous Si, <i>p</i> *-Si, thickness 2 μm, anodization	Ag dendrites, immersion, 10 <sup>-2</sup> M AgNO3, 5 min	R6G, 10 <sup>-9</sup> M Adenine, 10 <sup>-9</sup> M 488 nm	[83]
4	Mesoporous Si, <i>p</i> +-Si, <i>p</i> -Si, anodization	Ag NPs, diameter 50 – 150 nm, immersion, 10 <sup>-2</sup> M AgNO3, 10 min	tetrapyrrolic molecules H2TMpyP4, ZnTMpyP4, CuTMpyP4, H2TPPS, 10 <sup>-6</sup> M, 457.9, 532, 441.6 nm	[74]
5	Mesoporous Si, p⁺-Si, thickness 1µm, anodization	Ag NPs, immersion, 10 <sup>-3</sup> M AgNO <sub>3</sub> , 3 – 60 min, thermal decomposition, 500°C	Cyanine dye, 10 <sup>-7</sup> M, horseradish peroxidize, 10 <sup>-8</sup> M 514.5 nm	[92]

Table S1. Analysis of works on the SERS-active substrates based on metal-coated porous silicon.

6	Mesoporous Si, p*-Si, pore diameter 2-20 nm, thickness 1 μm, porosity 80%, anodization	Ag particles, 1) immersion, 10 <sup>-3</sup> M – 10 <sup>-2</sup> M AgNO <sub>3</sub> , thermal decomposition, 500°C 2) oxidation, thermal decomposition	Cyanine dye, 10 <sup>-7</sup> M, 514.5 nm	[75]
7	Mesoporous Si, p+-Si, pore diameter 20 – 40 nm, anodization	Ag NPs + dendrites, immersion, 10 <sup>-2</sup> – 10 <sup>-3</sup> M AgNO <sub>3</sub>	CuTMpyP4, 10 <sup>-6</sup> M, 457.9 nm,	[84]
8	Mesoporous Si, <i>n</i> <sup>+</sup> -Si, anodization	Au NPs, diameters 4.5 nm, 14.8 nm Colloidal on APTES	Benzenethiol, 10 <sup>-3</sup> M 785 nm	[114]
9	Mesoporous Si, <i>p</i> ⁻-Si, porosity 80 %, anodization	Ag particles, immersion, 10 <sup>-3</sup> M – 10 <sup>-2</sup> M, 50°C, 30 s – 10 min, thermal decomposition, 500°C	Cyanine dye, 10 <sup>-8</sup> M, 514.5 nm	[76]
10	Mesoporous Si, <i>p</i> ⁺-Si, anodization	Au particles, immersion, 10 <sup>-3</sup> , 10 <sup>-2</sup> , 5·10 <sup>-2</sup> M HAuCl <sub>4</sub>	R6G, 2·10 <sup>-5</sup> M 633 nm	[77]
11	Mesoporous Si, <i>p</i> Si, anodization	Ag particles, ink jet printing, 10 <sup>-2</sup> M AgNO <sub>3</sub>	Cyanine dye, 10-6 M, 514.5 nm	[78]
12	Mesoporous Si, pore diameter 2 – 20 nm, 80% porosity, anodization	Ag particles, immersion 1 – 10 mM AgNO <sub>3</sub> , 5 – 50°C, 30 s – 10 min	Cyanine dye, 10 <sup>-8</sup> – 10 <sup>-9</sup> M at 514.5 nm CGIYRLRS peptide in ddH2O, 10 <sup>-3</sup> M, 457.9, 514.5, 647 nm	[79]
13	Mesoporous Si, pore diameter 15 nm, thickness 6 μm, anodization	Ag NPs, immersion, 10 <sup>-3</sup> , 10 <sup>-2</sup> , 5·10 <sup>-2</sup> M AgNO <sub>3</sub>	R6G, 10 <sup>-12</sup> M at 514.5 nm, crystal violet, 10 <sup>-8</sup> M at 633 nm	[23]

Mesoporous Si, pore diameter 2 – 20 nm, 14 thickness 4 – 5 μm, porosity 80 %, anodization Mesoporous Si, <i>p</i> <sup>+</sup> -Si, pore diameter 15 nm, thickness 3, 13 μm,	Ag particles, immersion, best SERS for 10 <sup>-2</sup> M AgNO <sub>3</sub> , 50°C, 60 s Ag particles, diameter 10 nm – 5 μm, immersion	Cyanine dye, 10 <sup>-12</sup> M, 514.5 nm R6G, 10 <sup>-7</sup> M, 514.5 nm R6G, 10 <sup>-12</sup> M, 647 nm R6G, 10 <sup>-6</sup> M, 532 nm	[80] [81]
anodization Mesoporous Si, <i>p</i> Si, thickness 1.7 μm, porosity 64 %, anodization	10 <sup>-2</sup> , 5·10 <sup>-2</sup> M AgNO <sub>3</sub> , 120, 180, 210 s Ag NPs, ink jet printing, 2.5, 5·10 <sup>-2</sup> M AgNO <sub>3</sub>	Cyanine dye, 10 <sup>-6</sup> M, R6G 10 <sup>-12</sup> M, 514.5 nm	[117]
Mesoporous Si, <i>p</i> <sup>+</sup> -Si, pore diameter 30 nm, thickness 4.8 μm, porosity 35 %, anodization, oxidation	Au NPs/APTES, diameter 5 nm, colloidal deposition	Bovine serum albumine (BSA), 10 <sup>-8</sup> M, 488 nm R6G, 10 <sup>-8</sup> M, 633 nm	[94]
Meso- on macroporous Si, <i>p</i> Si, pore diameter of meso- 10 – 30 nm, pore diameter of macro- 1 – 3 μm, anodization	Ag NPs, diameter 30 nm, immersion, 10 <sup>-2</sup> M AgNO <sub>3</sub> , 3 min	R6G, 10 <sup>-15</sup> M, 514.5 nm	[89]
19 Mesoporous Si, <i>p</i> <sup>+</sup> -Si, anodization	Ag NPs, immersion, 10 <sup>-2</sup> M AgNO3, 30 s	Crystal violet, 10 <sup>-10</sup> M, 785 nm	[60]
Mesoporous Si, <i>p</i> -Si, 20 pore diameter 10, 15, 30, 40 nm, anodization	Ag NPs, immersion, 10 <sup>-1</sup> M HF, 10 <sup>-3</sup> , 2·10 <sup>-3</sup> , 3·10 <sup>-3</sup> , 5·10 <sup>-3</sup> M AgNO <sub>3</sub> , 10 min	Malachite green, 2·10 <sup>-7</sup> M, 532 nm	[61]

21	Mesoporous Si/PDMS membranes, <i>p</i> -Si, anodization	Ag NPs, 1) immersion, 10 <sup>-2</sup> M AgNO <sub>3</sub> , 50 °C 2) ink jet printing, 2.5·10 <sup>-2</sup> M AgNO3	<ol> <li>ink jet, R6G 10<sup>-12</sup> M, 514.5 nm</li> <li>immersion, R6G, 10<sup>-12</sup> M, 514.5 nm</li> <li>immersion on PDMS supported membrane, R6G, 10<sup>-14</sup> M, miRNA222, 485·10<sup>-12</sup> M</li> </ol>	[16]
22	Mesoporous Si <i>, p-</i> Si, anodisation	Ag particles, immersion, 10 <sup>-2</sup> – 10 <sup>-3</sup> M AgNO <sub>3</sub> , 30, 60, 90, 120, 300 s.	R6G, 10 <sup>.9</sup> M, 514.5 nm	[82]
23	Mesoporous Si disks, disk diameter 1 μm, pore diameter 50 nm, photolithography, anodization	Au nanorods, diameter 6–10 nm, length 30–50 nm, chemical deposition	4-mercaptobenzoic acid, 10 <sup>-8</sup> M, 785 nm	[99]
24	Mesoporous Si disks, p*-Si, disk diameter 1 μm, disk thickness 400 nm, pore diameter 20 – 60 nm, photolithography, anodization	Ag NPs/APTES, immersion, 4·10 <sup>-2</sup> M AgNO <sub>3</sub>	glutathione (DTNB – Raman reporter), 7.49·10 <sup>.8</sup> M, 785 nm	[63]
25	Mesoporous Si grating, p <sup>+</sup> -Si, pore diameter 25 nm, anodization, oxidation	Ag NPs/APTES, diameter 30 nm, colloidal deposition	R6G, 10 <sup>-12</sup> M, 785 nm	[64]

		Macroporous Si		
26	Macroporous Si, <i>p</i> Si, pore diameter 0.5 – 1.5 μm, anodization	Ag NPs, immersion, 10 <sup>-2</sup> – 10 <sup>-3</sup> M AgNO <sub>3</sub>	CuTMpyP4, 10 <sup>-6</sup> M, 457.9 nm	[84]
27	Macroporous Si, <i>p-</i> Si, pore diameter 1.5 – 1.7 μm, anodization	Au NPs (on Cr film, thickness 10 nm), diameter 70 nm, PVD	Thiol, 2·10 <sup>-3</sup> M, 785 nm	[95]
28	Macroporous Si, <i>p</i> -type, pore diameter 0.5–1 μm, anodization	Ag NPs/Ag colloidal NPs/APTES immersion, Ag2SO4	R6G, 2·10 <sup>-5</sup> M, 2·10 <sup>-8</sup> M 633 nm	[65]
29	Macroporous Si, <i>p</i> Si, anodization	Au NPs, diameter 50 nm, PVD	11-Mercaptoundecanoic acid, 2·10 <sup>-3</sup> M, 785 nm	[66]
30	Macroporous Si, <i>n</i> +-Si, pore diameter 100 nm, anodization	Au nanowires, length 300, 600, 900 nm electrodeposition	10 <sup>-4</sup> M 4-4'bypiridine, 633 nm	[16]
31	Macroporous Si, anodization	Au nanothorns on Au NPs, nanothorns length 50 nm – 1 μm, NPs diameter 5 – 20 nm, immersion	Crystal violet, 10 <sup>-15</sup> M, 633 nm	[108]
32	Macroporous Si, <i>n</i> Si, pore diameter 1.2 μm, anodization	Ag NPs, immersion	R6G, 10 <sup>-9</sup> M, 785 nm	[67]
33	Macroporous Si, pore diameter 500 – 1500 nm, anodization	Ag/Ni nanovoids, Ni electrodeposition, Ag immersion, 3 mM AgNO3	CuTMpyP4, 10 <sup>-6</sup> M, R6G, 10 <sup>-11</sup> M, 441.6 nm	[85]
34	Macroporous Si, p <sup>-</sup> -Si, pore diameter 1.2 μm, anodization	Ag dendrites on Ag NPs, immersion, 3·10 <sup>-3</sup> M AgNO3, HF, C2H5OH, 80 min	CuTMpyP4, 10 <sup>-10</sup> M, 473 nm	[109]

35	Meso- on macroporous Si, $p$ Si, mesopore diameter $10 - 30$ nm, macropore diameter $1 - 3$ $\mu$ m, anodization	Ag NPs, diameter 30 nm, immersion, 10 <sup>-2</sup> M AgNO <sub>3</sub> , 3 min	R6G, 10 <sup>-15</sup> M, 514.5 nm	[89]
36	Macroporous Si, <i>p</i> Si, anodization	Au, Ag NPs, 1) immersion, 10 <sup>-2</sup> , 10 <sup>-3</sup> M AgNO <sub>3</sub> , Ag NPs diameter 100 nm, 2) Ag colloidal deposition, Ag NPs diameter 80 nm, 3) Au, Ag PLD, Au, Ag NPs diameter 20 – 40 nm	1) Ag immersion, R6G, 10 <sup>-9</sup> M, 514.5 nm 2) Ag colloid, R6G, 10 <sup>-8</sup> M, 514.5 nm 3) Ag, Au PLD, R6G, 10 <sup>-8</sup> M, 514.5 nm Ag PLD, methylene blue, 10 <sup>-10</sup> M, 633 nm, Au PLD, methylene blue, 10 <sup>-8</sup> M, 633 nm	[68]
37	Macroporous Si, <i>n</i> Si, pore diameter 2 μm, thickness 10 μm, anodization	Au, Ag NPs, electrodeposition, 9·10 <sup>-3</sup> M HAuCl4, 9·10 <sup>-3</sup> M AgNO3	R6G, 10 <sup>-3</sup> M, 633 nm,	[69]
38	Macroporous Si, <i>n</i> Si, anodization	AuNPs, immersion, 10 <sup>-2</sup> , 5·10 <sup>-3</sup> M HAuCl4, 2.9 M HF, 3 min	Cyanine dye, 10 <sup>-4</sup> , 10 <sup>-6</sup> , 10 <sup>-10</sup> M, 514.5 nm	[110]
39	Macroporous Si, p⁻-Si, SiO₂ thickness 250 nm, pore diameter 500 nm, anodization, oxidation	Ag dendrites, immersion, 2·10 <sup>-2</sup> M AgNO <sub>3</sub> , 5 M HF, 30 s, 20 – 50 °C	nile blue, 10 <sup>-6</sup> M, 473, 532, 633 nm	[112]

		Porous Si type is not specified		
40	<i>p-</i> Si, MACE, 2.5 M NH₄F, 10⁻² M AgNO₃, 50°C	Ag dendrites, grown during porous Si formation by MACE	Rhodamine B, 10 <sup>-5</sup> M, 633 nm	[49]
41	<i>p</i> -Si, anodization	Ag NPs, diameter 100 nm, immersion, 10 <sup>-3</sup> – 10 <sup>-1</sup> M AgNO <sub>3</sub>	R6G, 10 <sup>-10</sup> M, 514.5 nm ZnTMpyP4, FeTSPP, 10 <sup>-6</sup> M, 457.9 nm	[106]
42	<i>p</i> -Si, anodization	Ag NPs, immersion, AgNO3	chlorine e6, 10 <sup>-7</sup> M, 457.9 nm, 514.5 nm,	[118]
43	<i>p</i> Si, anodization	Ag NPs, immersion	R6G, 10⁻⁵ M, 514.5 nm	[105]
44	<i>p</i> −-Si, anodization	Ag NPs, immersion, 10-2 M AgNO3	ZnTMPyP4, 10 <sup>-6</sup> M, 441.6, 532 nm	[70]
45	pSi, anodization	Ag NPs, immersion	Sb-phenylfluorone complex, 532 nm	[71]
46	p⁻-Si, anodization	Ag NPs, diameter 50-100 nm, immersion at ultrasonication, best SERS at 10 <sup>-2</sup> M AgNO <sub>3</sub> , 30 s	p-thiocresol, 5.2·10 <sup>.9</sup> M, 2,4,6-trinitrotoluene, 1.1·10 <sup>.7</sup> M, 633 nm	[116]
47	p⁺-Si, anodization	Ag dendrites on NPs, immersion, 10 <sup>-2</sup> M AgNO3, 4 °C, 5 min. Sb	Sb-phenylfluorone complex, limit of Sb detection 1 ng/mL, 514.5, 532 nm	[120]
48	n⁻-Si, 1) light-induced etching, 2) anodization	Ag NPs, immersion, 10 <sup>-2</sup> M AgNO <sub>3</sub> , 15 min	R6G, 10 <sup>-15</sup> M, 514.5 nm	[72]
49	p⁺-Si¹, anodization	Au film, thickness 10, 30, 50, 100, 200, 300 nm, PVD	p-mercptobenzoic acid, 10 <sup>-2</sup> M, human blood, cerebrospinal fluid, urine, 785 nm	[97]

		Si nanotips, nanowires, nanopilla	rs	
50	Poly-Si nanopillars, height 0.1 – 0.3 μm, diameter 20 – 100 nm, reactive ion etching	Au layer, thickness 10 – 20 nm, evaporation	4',6-diamidino-2-phenylindole (DAPI), 10 <sup>-3</sup> M, 785 nm	[34]
51	Poly-Si nanopillars, height 250 nm, diameter 40 nm, reactive ion etching	Ag film, thickness 50 nm, oxidation, thermal decomposition	R6G, 10 <sup>-9</sup> M, 785 nm	[35]
52	Si nanotips, height 1 µm, diameter 2 (top) – 100 (bottom) nm, reactive ion etching	Ag NPs, diameter 4 – 10 nm, ion beam sputtering	R6G, trans-1,2-bis(4-pyridyl)ethylene (BPE) 10 <sup>-6</sup> – 10 <sup>-10</sup> M, 532 nm	[36]
53	Si nanowires, MACE, AgNO3/HF, HF/Fe(NO3))3	Ag film/colloidal Au NPs/ 3-aminopropyltrimethoxysilane (APTMS), immersion	R6G, 5·10 <sup>-7</sup> M, amoxicillin , 10 <sup>-6</sup> – 10 <sup>-9</sup> M, calcium dipicolinate, 4·10 <sup>-6</sup> M, 514.5 nm	[50]
54	Si nanowires <i>, p</i> Si, MACE, vapor liquid (VLS)	Ag NPs, diameter 4 – 40 nm, immersion, 10 <sup>-3</sup> M AgNO3, 0.26 M HF, 60s	R6G, For VLS substrates 10 <sup>-14</sup> M For MACE substrates 10 <sup>-9</sup> M 633 nm	[51]
55	Nanoporous Si pillars, hydrothermal etching	Ag NPs, diameters 30 – 120 nm, 400 – 1000 nm, immersion, 10 <sup>-2</sup> M AgNO3, 5 min	Adenine, 10 <sup>-4</sup> – 10 <sup>-6</sup> M, 532 nm	[46]
56	Nanoporous Si pillars, <i>p</i> <sup>+</sup> -Si, hydrothermal etching	Cu NPs, immersion, 10 <sup>-3</sup> M CuCl <sub>2</sub>	R6G, 10 <sup>-5</sup> M, 633 nm	[47]

57	Si nanowires, oxide-assisted growth via thermal evaporation of Si monoxide	Ag NPs, immersion, drop of 1 M AgNO3 after 10 <sup>-1</sup> M NaOH, 15 min	DNA 10 <sup>-15</sup> M, 633nm	[73]
58	Si nanopillars, length 600 – 1600 nm, gap between pillars 50 – 80 nm, reactive ion etching	1) Oval-shaped Ag NPs, electron-beam evaporation 2) Ag coating, magnetron sputtering	Thiophenol gas, BPE, 10 <sup>-3</sup> M 785 nm	[37]
59	Porous Si pillars, <i>p</i> +-Si, hydrothermal etching	Ag particles, diameters 70 nm, 100 – 1000 nm, immersion,10 <sup>-2</sup> M AgNO3, 1 – 10 min	532 nm R6G, 10 <sup>-15</sup> M	[48]
60	Si nanopillars, nanosphere lithography, wet chemical etching, MACE	Ag coating, electrodeposition, AgNO3, H2BO3	R6G, 10 <sup>-6</sup> M, 488 nm	[52]
61	Si nanowires, <i>p-</i> Si, MACE	Au film, thickness 30 – 300 nm, sputtering	1,2-benzenedithiol (BDT), 10 <sup>-5</sup> M, 785 nm	[53]
62	Si nanopillars, undoped Si, height 750 nm, gap between pillars 50 – 80 nm, reactive ion etching	Oval-shaped Au NPs, length 250 nm, aptamers for detection of analyte, electron-beam evaporation	TAMPA-labeled vasopressin (TVP), 10 <sup>-12</sup> M, 633 nm	[38]
63	Si nanopillars, undoped Si, height 750 nm, gap between pillars 50 – 80 nm, reactive ion etching	Microfluidic device, oval-shaped Au NPs, length 250 nm, aptamers for detection of analyte, electron-beam evaporation	TVP, 2·10 <sup>-10</sup> M, 633 nm	[39]
64	Si nanopillars, height 400 nm, gap between pillars 200 nm, reactive ion etching	Ag oval-shaped NPs, diameter 62 nm, evaporation	covalent diphenylalanine nanotube-folic acid conjugates, 780 nm	[40]

		Oval shaped A g NPs	ethanol vapor, 0.0017 ng,	
65	Si nanopillars, undoped Si,	electron-beam evaporation	acetone vapor 0.0037 ng,	[41]
	reactive ion etching	electron-beam evaporation	633 nm	

66	Si nanopillars, height 600 nm, width 50 nm, reactive ion etching	Oval-shaped Ag NPs, height 300 nm, width 120 nm, electron-beam evaporation	Folic acid, 10 <sup>-9</sup> M, 532nm	[42]
67	Si nanopillars, height 400 nm, width 50 nm, reactive ion etching	Oval-shaped Au NPs, evaporation	HCN gas, 5 ppm, KCN liquid, 18 ppb (10⁵ M), 780 nm	[43]
68	Si nanopillars, $p$ -Si, reactive ion etching	Ag NPs (on Cr film, thickness 3 nm), electron beam evaporation	BPE, 10 <sup>-11</sup> M, 780 nm	[44]
69	Si nanopillars, reactive ion etching	Oval-shaped Au NPs, evaporation	nerve gases VX, 1.3·10 <sup>-14</sup> M, Tabun, 6.7·10 <sup>-13</sup> M, 785 nm	[45]
70	Oxidized porous Si, <i>p</i> *-Si, anodization	Au NPs, diameter 30 nm, PVD	R6G, 10 <sup>-6</sup> M, 633 nm	[96]
71	Si nanowires, CVD	Au NPs, immersion, CVD of graphene	R6G, 10 <sup>-6</sup> M, 532, 785 nm	[87]
72	Si nanopillars, p-Si, height 10 μm, MACE	Ag dendrites, immersion, 10-2 M AgNO3, 4.6 M HF, 120 s	thiophenol, 10 <sup>-2</sup> M, mixture of R6G, methylene blue, 10 <sup>-4</sup> M, 785 nm	[54]